

ALLENG4.001AUS

PATENT



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Kripesh et al.  
Appl. No. : 10/078,243  
Filed : February 14, 2002  
For : PROCESS OF FORMING METAL  
SURFACES COMPATIBLE WITH  
A WIRE BONDING AND  
SEMICONDUCTOR  
INTEGRATED CIRCUITS  
MANUFACTURED BY THE  
PROCESS  
Examiner : L. A. Gurley  
Group Art Unit : 2812

CERTIFICATE OF MAILING

I hereby certify that this correspondence and all  
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the United States Postal Service as first-class  
mail in an envelope addressed to:  
Commissioner for Patents, P.O. Box 1450,  
Alexandria, VA 22313-1450, on

December 29, 2004

(Date)

John M. Carson, Reg. No. 34,303

AMENDMENT AND RESPONSE TO FINAL OFFICE ACTION

**Mail Stop AF**  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the final Office Action mailed September 30, 2004, Applicant respectfully submits the following amendments and remarks in connection with the above-captioned application.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks** begin on page 9 of this paper.